



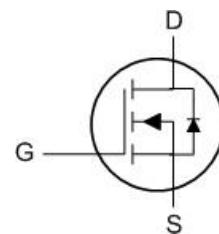
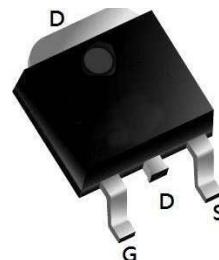
- ★ Super Low Gate Charge
- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench

technology

Product Summary

BVDSS	RDS(on)	ID
30V	2.8mΩ	100A

TO252-3L Pin Configuration



Description

The XR100N03C is the high cell density trenched N-ch MOSFETs, which provide excellent RDS(on) and gate charge for most of the synchronous buck converter applications.

The XR100N03C meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ^{1,6}	100	A
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ^{1,6}	60	A
I _{DM}	Pulsed Drain Current ²	480	A
EAS	Single Pulse Avalanche Energy ³	256	mJ
I _{AS}	Avalanche Current	---	A
P _D @T _C =25°C	Total Power Dissipation ⁴	75	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R _{θJA}	Thermal Resistance Junction-Ambient ¹	---	---	°C/W
R _{θJC}	Thermal Resistance Junction-Case ¹	---	2	°C/W

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	HD	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_D=1\text{mA}$	---	---	---	$\text{V}/^\circ\text{C}$
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance ²	$V_{\text{GS}}=5\text{V}$, $I_D=4.5\text{A}$	---	G $\ddot{\text{E}}$	H $\ddot{\text{E}}$	$\text{m}\Omega$
		$V_{\text{GS}}=1.5\text{V}$, $I_D=3.5\text{A}$	---	I $\ddot{\text{E}}$	I $\ddot{\text{E}}$	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D=250\mu\text{A}$	F	F $\ddot{\text{E}}$	G $\ddot{\text{E}}$	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	---	---	$\text{mV}/^\circ\text{C}$
I_{DSs}	Drain-Source Leakage Current	$V_{\text{DS}}=10\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	uA
		$V_{\text{DS}}=10\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=100^\circ\text{C}$	---	---	100	
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 0.5\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}$, $I_D=0.5\text{A}$	---	G $\ddot{\text{E}}$	---	S
R_g	Gate Resistance	$V_{\text{DS}}=0\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	F $\ddot{\text{E}}$	---	Ω
Q_g	Total Gate Charge	$V_{\text{DS}}=1\text{V}$, $V_{\text{GS}}=5\text{V}$, $I_D=0.5\text{A}$	---	I $\ddot{\text{I}}$	---	nC
Q_{gs}	Gate-Source Charge		---	I $\ddot{\text{G}}$	---	
Q_{gd}	Gate-Drain Charge		---	J $\ddot{\text{E}}$	---	
$T_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{GS}}=5\text{V}$, $V_{\text{DD}}=1\text{V}$, $R_G=1\Omega$, $I_D=0.5\text{A}$	---	F $\ddot{\text{I}}$	---	ns
T_r	Rise Time		---	H $\ddot{\text{I}}$	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time		---	I $\ddot{\text{H}}$	---	
T_f	Fall Time		---	G $\ddot{\text{G}}$	---	
C_{iss}	Input Capacitance	$V_{\text{DS}}=1\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	G $\ddot{\text{I}}$	---	pF
C_{oss}	Output Capacitance		---	G $\ddot{\text{J}}$	---	
C_{rss}	Reverse Transfer Capacitance		---	G $\ddot{\text{I}}$	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current ^{1,4}	$V_G=V_D=0\text{V}$, Force Current	---	---	100	A
V_{SD}	Diode Forward Voltage ²	$V_{\text{GS}}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1.2	V
t_{rr}	Reverse Recovery Time	$IF=0.5\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	I $\ddot{\text{I}}$	---	nS
			---	I $\ddot{\text{G}}$	---	nC

Note :

FF the data is tested by a surface mounted on a 1 inch² FR-4 board with 2OZ copper.G $\ddot{\text{E}}$ the data is tested by pulsed pulse width $\leq 300\text{us}$ duty cycle $\leq 2\%$.H $\ddot{\text{E}}$ the EAS data shows Max. Rating at the test condition As A/R/V/G » O, $V_{\text{DD}}=30\text{V}$, $V_{\text{G}}=10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$ I $\ddot{\text{E}}$ the power dissipation is limited by 150°C junction temperatureI $\ddot{\text{E}}$ the data is theoretically the same as I_{DSS} and I_{DMA} . In real applications, it should be limited by total power dissipation.

Typical Electrical And Thermal Characteristics (Curves)

Figure 1. Output Characteristics

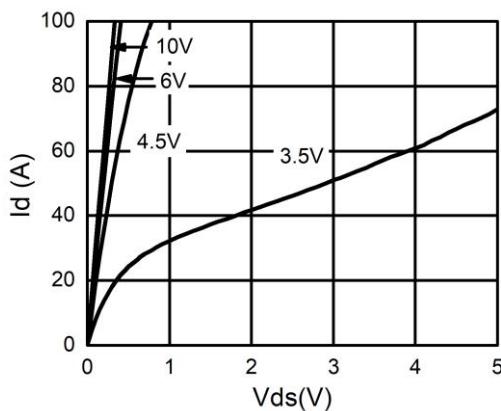


Figure 2. Transfer Characteristics

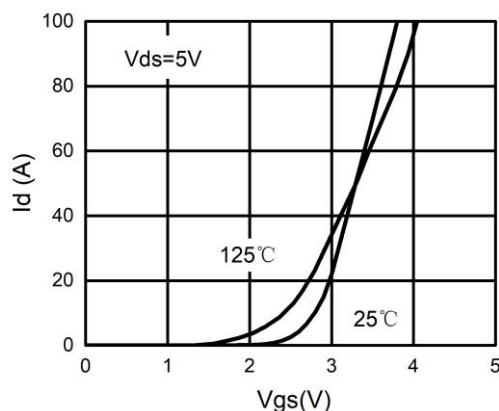


Figure 3. Power Dissipation

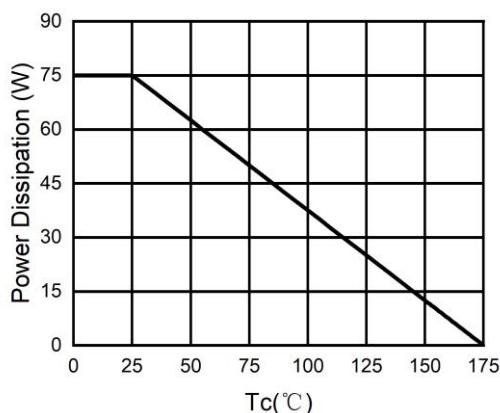


Figure 4. Drain Current

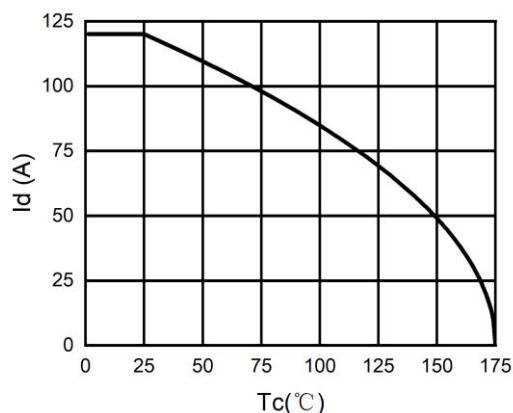


Figure 5. BV_{DSS} vs Junction Temperature

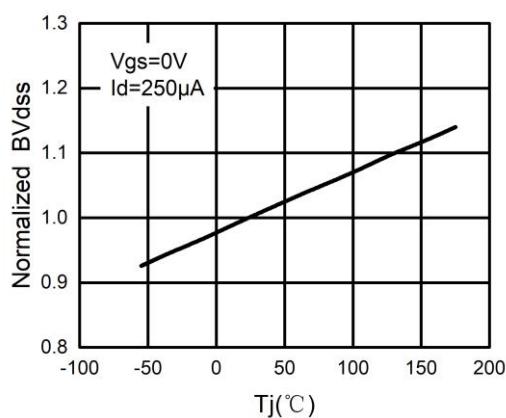


Figure 6. R_{DS(ON)} vs Junction Temperature

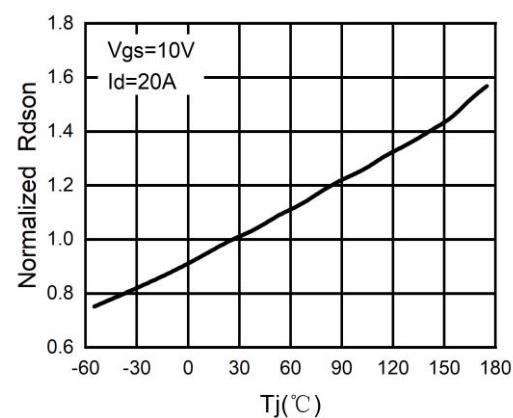


Figure 7. Gate Charge Waveforms

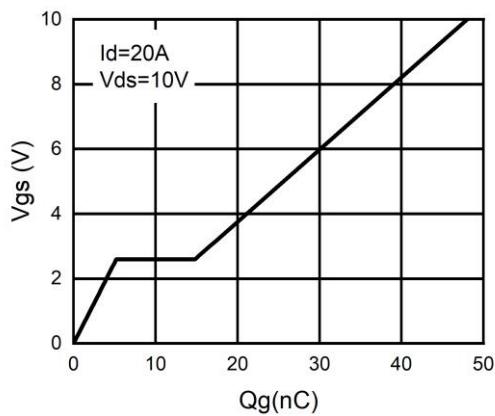


Figure 8. Capacitance

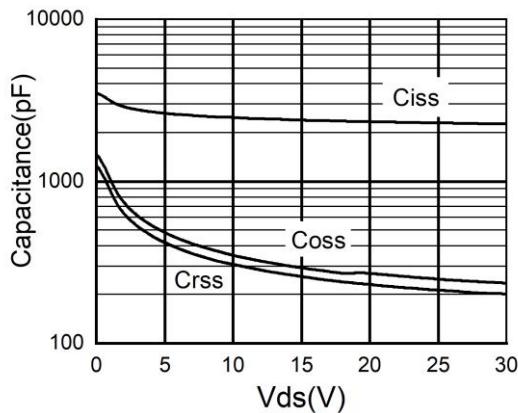


Figure 9. Body-Diode Characteristics

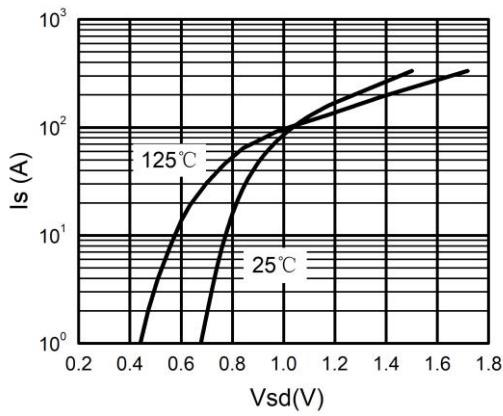
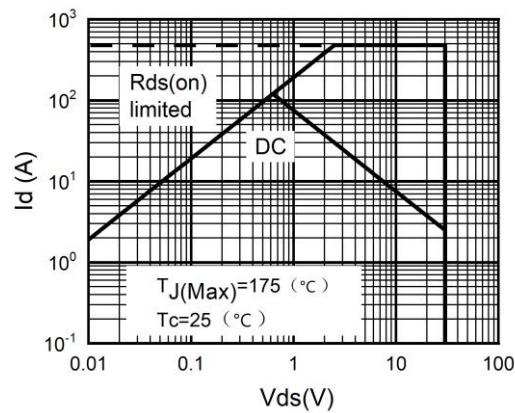
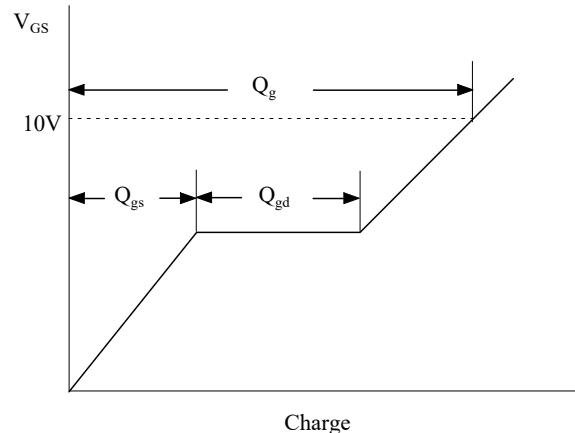
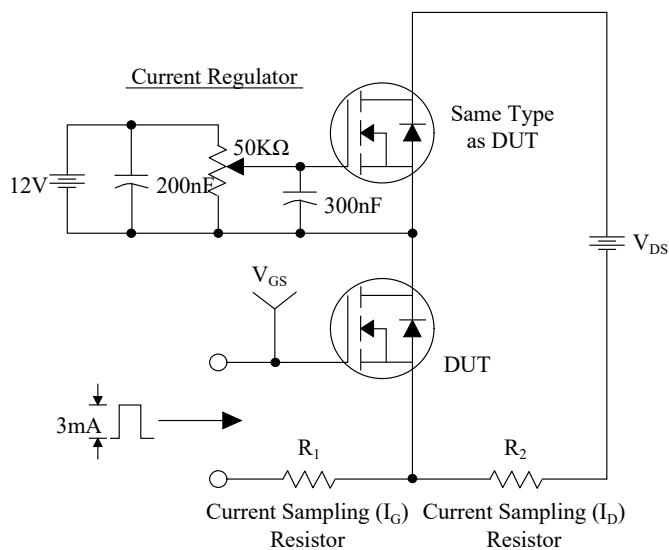


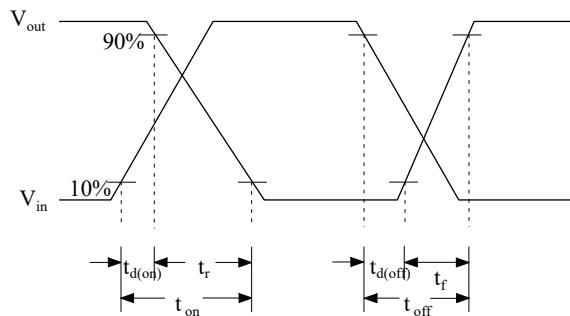
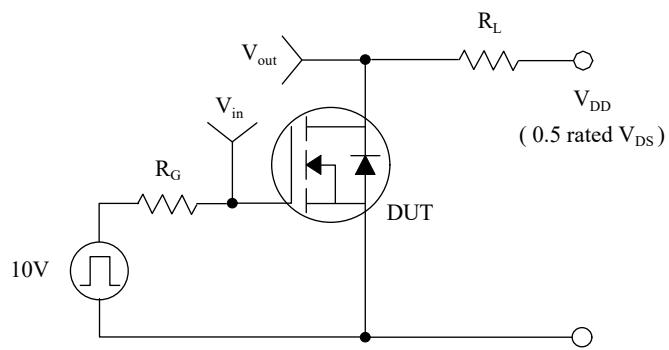
Figure 10. Maximum Safe Operating Area



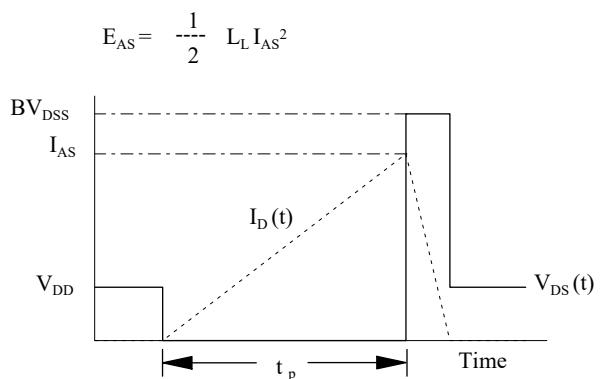
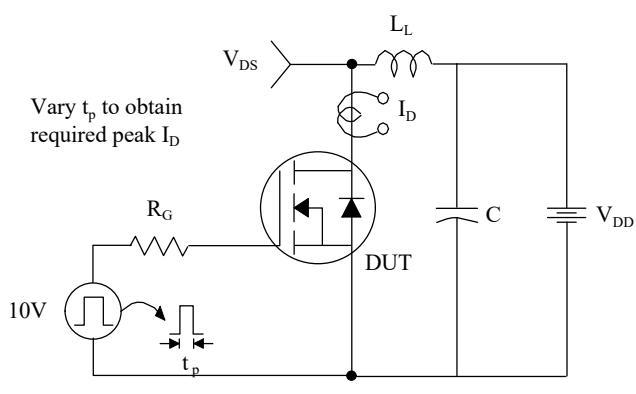
Gate Charge Test Circuit & Waveform



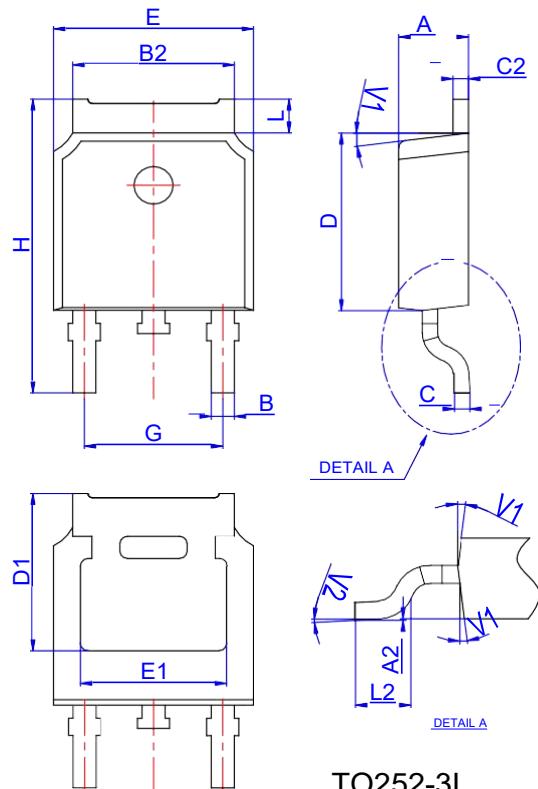
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

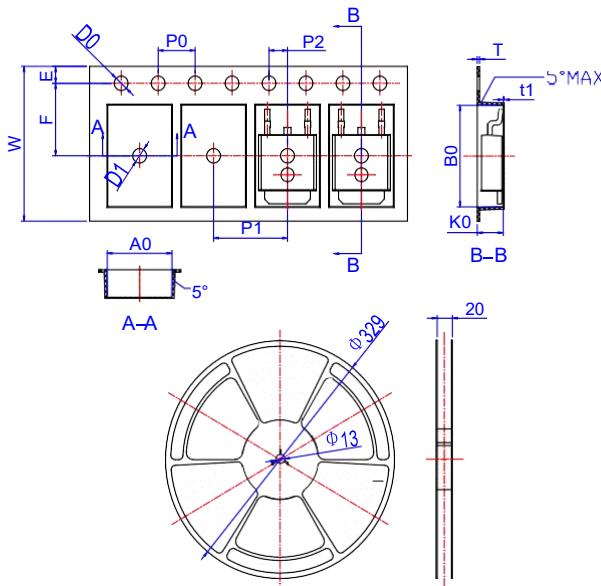


Package Mechanical Data TO252-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Specification-TO252-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583